

Features

- Low Clamping Voltage
- Working Voltages: 24V
- Low Leakage Current
- Fully OPEN Alliance 100BASE-T1 and 1000BASE-T1 compliant
- AEC-Q101 Qualified

IEC COMPATIBILITY (EN61000-4)

- IEC 61000-4-4 (EFT) 40A (5/50ns)
- IEC 61000-4-5 (Lightning) 2A (8/20μs)

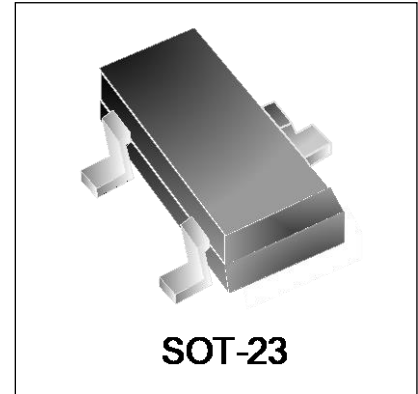
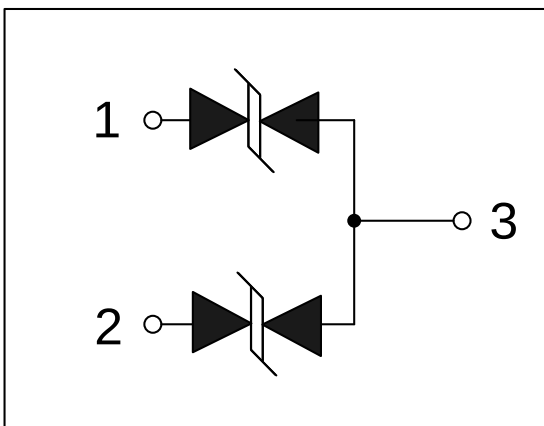
Mechanical Characteristics

- JEDEC SOT-23 package
- Marking: Marking Code
- Packaging: Tape and Reel per EIA 481
- RoHS Compliant & HF
- Device meets MSL1 requirement

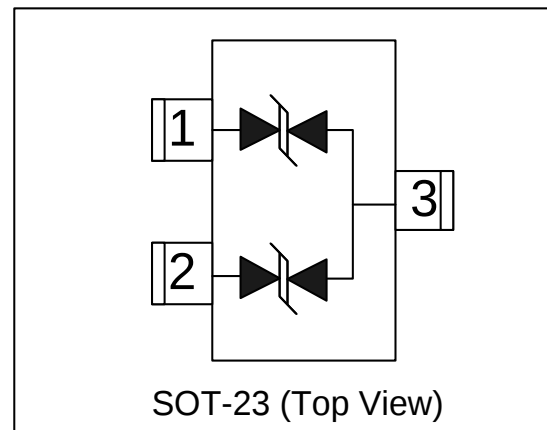
Applications

- RS-232, RS-422 & RS-485
- Cellular Handsets and Accessories
- Control & Monitoring Systems
- Portable Electronics
- Set-Top Box
- Servers, Notebook, and Desktop PC
- Wireless Bus Protection

Circuit Diagram



Schematic & PIN Configuration

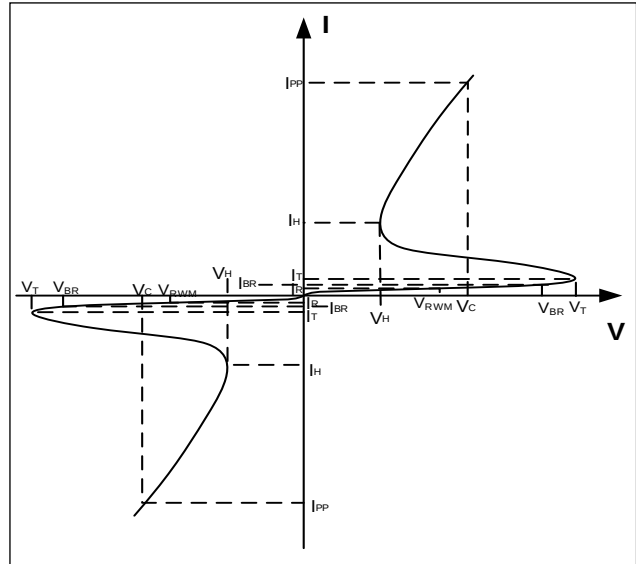


Absolute Maximum Rating

Rating	Symbol	Conditions	Value	Units
Peak Pulse Current	I_{PP}	$t_p = 8/20\mu s$	2	A
electrostatic discharge voltage	V_{ESD}	IEC 61000-4-2; contact discharge	30	kV
		ISO 10605; contact discharge; $C = 150\text{ pF}$; $R = 330\ \Omega$	30	kV
		ISO 10605; contact discharge; $C = 330\text{ pF}$; $R = 330\ \Omega$	18	kV
		1000 contact discharges (IEC 61000-4-2); OPEN Alliance specification	15	kV
Operating Temperature	T_J		-55 to + 150	°C
Storage Temperature	T_{STG}		-55 to +150	°C

Electrical Parameters

Symbol	Parameter
I_{PP}	Reverse Peak Pulse Current
V_C	Clamping Voltage
V_{RWM}	Reverse Stand-Off Voltage
I_R	Reverse Leakage Current
V_{BR}	Reverse Breakdown Voltage
I_{BR}	Reverse Breakdown Current
V_T	Reverse Trigger Voltage
I_T	Reverse Trigger Current
V_H	Reverse Holding Voltage
I_H	Reverse Holding current



Electrical Characteristics(T=25°C unless otherwise noted)

WE7218WT-AT						
Parameter	Symbol	Conditions	Minimum	Typical	Maximum	Units
Reverse Stand-Off Voltage	V_{RWM}				24	V
Reverse Holding Voltage	V_H	$t_p=100ns$	28	34		V
Reverse Trigger Voltage	V_T	$t_p=100ns$	100	114		V
Reverse Leakage Current	I_R	$V_{RWM}=24V$			100	nA
Dynamic Resistance ^{1,2}	R_{DYN}	$TLP=0.2/100ns$		0.4		Ω
ESD Clamping Voltage ¹	V_C	$I_{PP} = 4A$, $t_p = 0.2/100ns$ (TLP)		35		V
ESD Clamping Voltage ¹	V_C	$I_{PP} = 16A$, $t_p = 0.2/100ns$ (TLP)		40		V
Junction Capacitance	C_j	Pin 1 to 3 and Pin 2 to 3 $V_R = 0V$, $f = 1MHz$		1.6	2	pF

Notes : 1、TLP Setting : $t_p=100ns$, $t_r=0.2ns$, I_{TLP} and V_{TLP} sample window: $t_1=70ns$ to $t_2=90ns$.

2、Dynamic resistance calculated from $I_{PP}=4A$ to $I_{PP}=16A$ using "Best Fit".

Typical Characteristics

Figure 1: Peak Pulse Power vs. Pulse Time

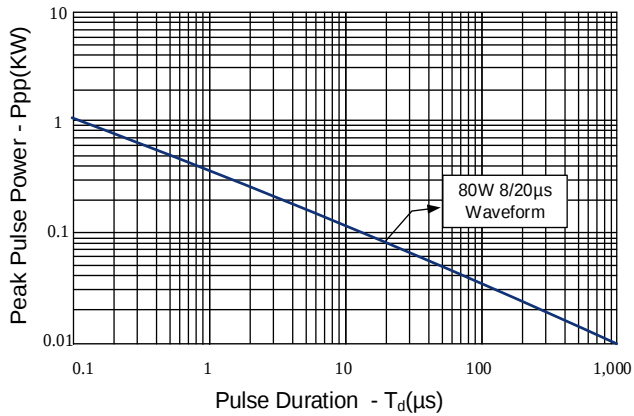


Figure 2: Power Derating Curve

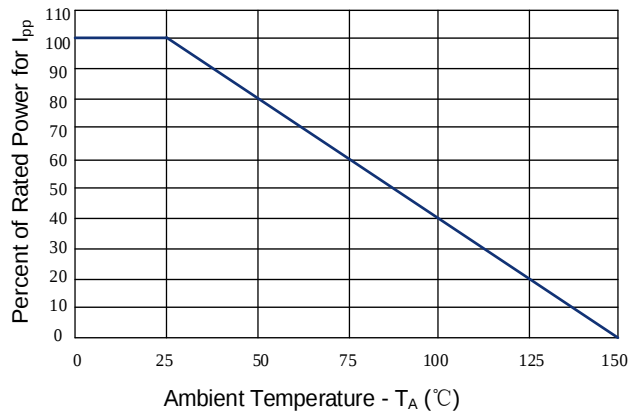


Figure 3: Normalized Junction Capacitance vs. Reverse Voltage

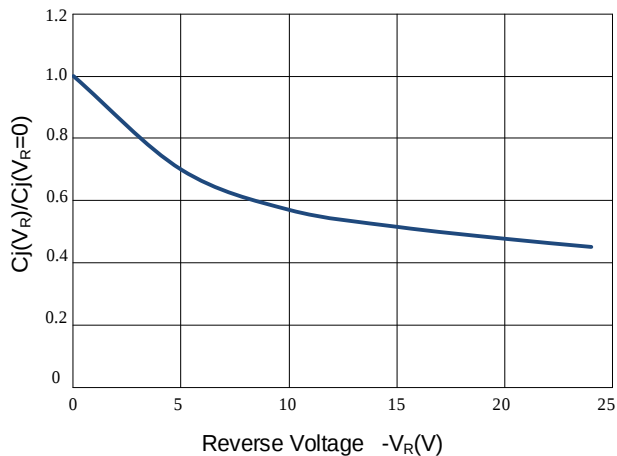


Figure 4: TLP Positive I-V Curve

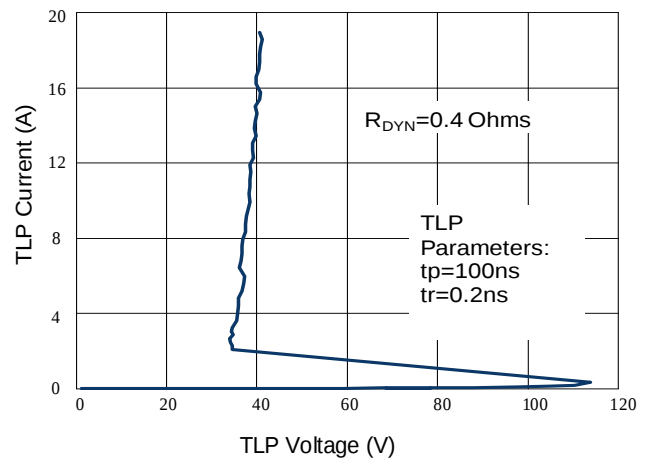


Figure 5: TLP Negative I-V Curve

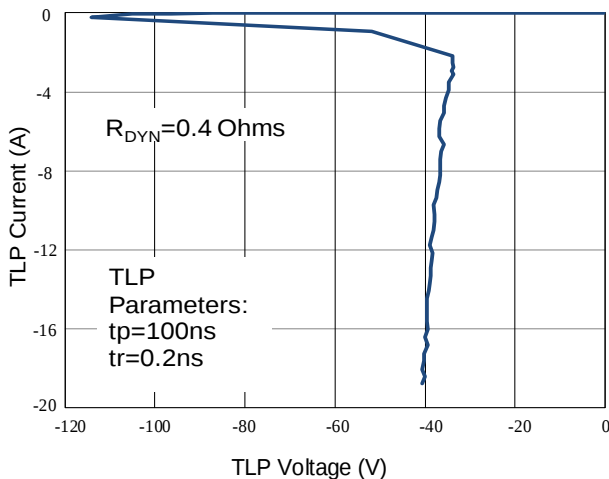
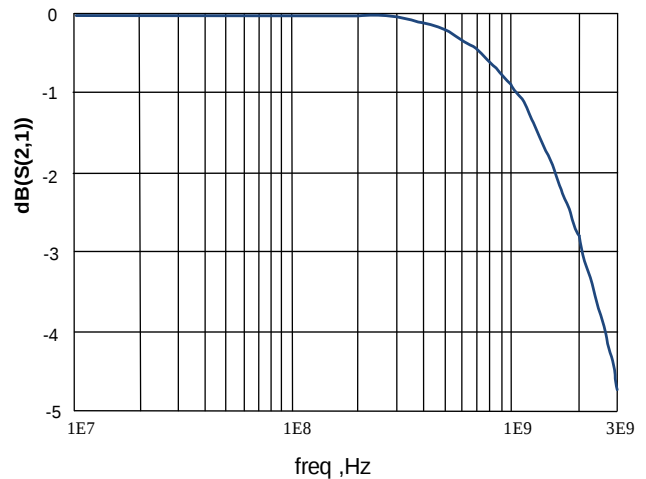
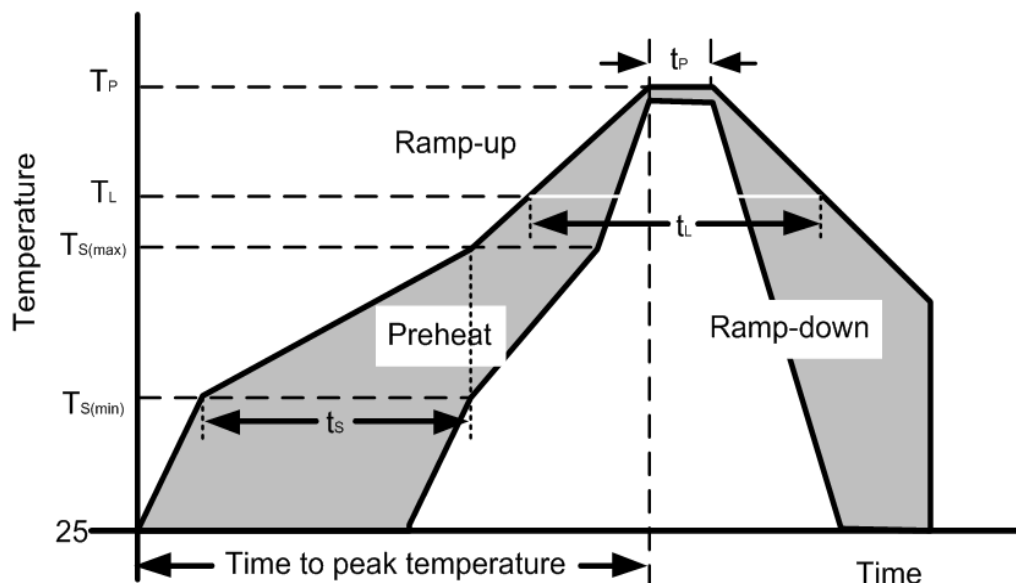


Figure 6: Insertion loss



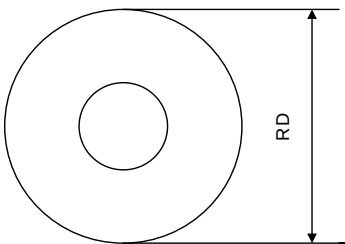
Soldering Parameters

Reflow Condition		Pb – Free assembly
Pre Heat	Temperature Min ($T_{s(min)}$)	150°C
	Temperature Max ($T_{s(max)}$)	200°C
	Time (min to max) (t_s)	60 – 190 secs
Average ramp up rate (Liquidus Temp) (T_L) to peak		5°C/second max
$T_{s(max)}$ to T_L ——Ramp-up Rate		5°C/second max
Reflow	Temperature (T_L) (Liquidus)	217°C
	Temperature (t_L)	60 – 150 seconds
Peak Temperature (T_P)		260+0/-5 °C
Time within actual peak Temperature (t_p)		20 – 40 seconds
Ramp-down Rate		5°C/second max
Time 25°C to peak Temperature (T_P)		8 minutes Max.
Do not exceed		280°C

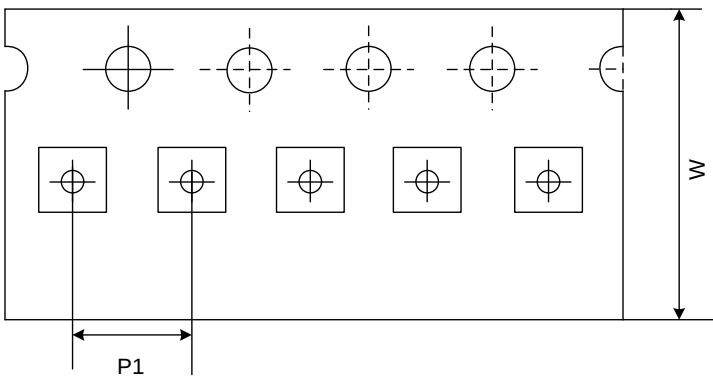


Tape And Reel Information

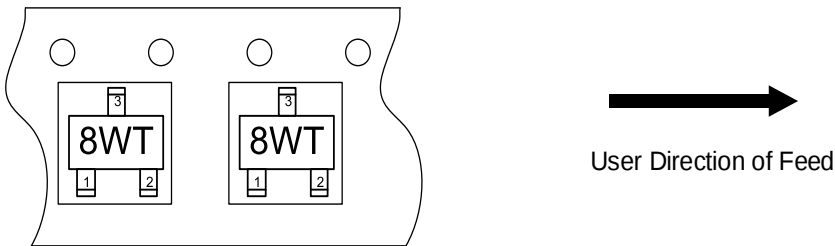
Reel Dimensions



Tape Dimensions



Quadrant Assignments For PIN1 Orientation In Tape



RD	Reel Dimensions	7 inch
W	Overall width of the carrier tape	8 mm
P1	Pitch between successive cavity centers	4mm

Outline Drawing – SOT-23

PACKAGE OUTLINE

Technical drawing of the SOT-23 package outline. The top view shows dimensions D (total width), E (total height), E1 (height to the top of the central pad), b (width of the central pad), e (width of the side pads), and e1 (total width of the pads). The side view shows dimensions A (total height), A1 (height to the top of the central pad), and A2 (height to the top of the side pads). The cross-sectional view shows the lead profile with a 0.25mm radius, a lead thickness of 0.08mm, a lead width of 0.30mm, a lead length of 0.50mm, and a lead angle of 8°.

SOT-23

DIMENSIONS

SYMBOL	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	0.90	1.15	0.035	0.045
A1	0.00	0.10	0.000	0.004
A2	0.60	0.70	0.024	0.028
b	0.30	0.50	0.012	0.020
c	0.08	0.15	0.003	0.006
D	2.80	3.00	0.110	0.118
E	2.25	2.55	0.089	0.100
E1	1.20	1.40	0.047	0.055
e	0.95 BSC		0.037 BSC	
e1	1.80	2.00	0.071	0.079
L	0.30	0.50	0.012	0.020
θ	0	8°	0	8°

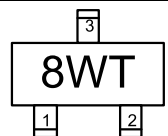
DIMENSIONS

DIM	INCHES	MILLIMETERS
M	0.0795	2.02
C	0.0315	0.80
Z	0.111	2.82
e	0.037 BSC	0.95 BSC
e1	0.075 BSC	1.9 BSC
b	0.0315	0.80

Notes:

Controlling Dimension: Millimeter.

Marking Codes

Part Number	WE7218WT-AT
Marking Code	

Package Information

Qty: 3k/Reel

CONTACT INFORMATION

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For additional information, please contact your local Sales Representative.

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Specifications are subject to change without notice...
 The device characteristics and parameters in this data sheet can and do vary in different applications and actual device performance may vary over time...
 Users should verify actual device performance in their specific applications...